Product datasheet **Characteristics**

BMEP584020

processor module M580 - Level 4 - Distributed





Main	
Range of product	Modicon M580
Product or component type	Processor module
Supply	Internal power supply via rack

Complementary

Number of racks	8	
Discrete I/O processor capacity	4096 I/O	
Analogue I/O processor capacity	1024 I/O	
Number of application specific channel	144	
Application specific I/O	Accurate time stamping Counter Serial link Motion control HART SSI encoder	
Checks	Process control	
Control channels	Programmable loops	
Integrated connection type	USB type mini B 1 Ethernet TCP/IP service port 2 Ethernet TCP/IP device network	
Number of distributed equipment	128	
Communication module processor capacity	8 AS-Interface module 4 Ethernet communication module	
Communication service	DIO scanner	
Memory description	Expandable flash 4 GB data storage Integrated RAM 10 kB system memory Integrated RAM 16 MB program Integrated RAM 2048 kB data	
Application structure	1 cyclic/periodic master task 1 periodic fast task 128 event tasks 2 auxiliary tasks	
Number of instructions per ms	30 Kinst/ms 65 % Boolean + 35 % fixed arithmetic 40 Kinst/ms 100 % Boolean	
Current consumption	295 mA 24 V DC	
MTBF reliability	600000 H	
Marking	CE	
Status LED	 LED green processor running (RUN) LED red I/O module fault (I/O) LED red processor or system fault (ERR) LED green download in progress (DL) LED red memory card or CPU flash fault (BACKUP) LED green/red ETH MS (Ethernet port configuration status) LED green/red Eth NS (Ethernet network status) 	
Product weight	0.849 kg	
Product weight Environment	1 LED green/red Eth NS (Ethernet network status)	
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Environment



vibration resistance	3 gn
shock resistance	30 gn
ambient air temperature for operation	060 °C
ambient air temperature for storage	-4085 °C
operating altitude	02000 m 20005000 m (with derating factor)
relative humidity	595 % 55 °C conforming to without condensation
IP degree of protection	IP20
directives	2012/19/EU - WEEE directive 2014/30/EU - electromagnetic compatibility 2014/35/EU - low voltage directive
standards	EN 61000-6-2 EN 61000-6-4 EN 61131-2 EN 61010-2-201
product certifications	CE CSA UL RCM Merchant Navy EAC

Offer Sustainability

Sustainable offer status	Green Premium product
RoHS (date code: YYWW)	Compliant - since 1623 - Schneider Electric declaration of conformity
REACh	Reference not containing SVHC above the threshold
Product environmental profile	Available
Product end of life instructions	Available

CPU Module Only



Modules Mounted on Racks



- a: additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the value is 29.49 mm (1.161 in.).
- **b:** the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).
- c: the height of the main local rack, 134.6 mm (5.299 in.)

Modules and Cables Mounted in an Enclosure





a: enclosure depth: 135 mm (5.315 in.)

- **b:** wiring + module depth: > 146 mm (5.748 in.)
- c: wiring + module + DIN rail depth: > 156 mm (6.142 in.)
- d: rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.)
- **e:** module height: 134.6 mm (5.299 in.)

